

MAXIMUM SECURITY, SPEED, AND SCALE FOR WEB INFRASTRUCTURE

KEY FEATURES AND BENEFITS

- World's first 128-thread, generalpurpose 2RU server powered by the ground breaking SPARC T3 processor.
- Increase your application performance and tackle the most demanding workloads with a 2x throughput, 2x the memory and 4x the I/O bandwidth improvement of its record-breaking predecessor.
- Consolidate from one virtual machine per core all the way to 128 virtual machines on one single server with built-in, no cost, Oracle VM Server for SPARC and Oracle Solaris Containers.
- Integrated on-chip cryptographic acceleration and 10 Gigabit Ethernet (GbE) enable secure computing at wire speed.
- Sleek, compact, well integrated design with highly expandable internal storage and network connectivity.
- Upgrade from any other legacy UltraSPARC based system at minimal cost and effort thanks to the unique binary compatibility features of Solaris.

SPARC T3-1 SERVER

Oracle's SPARC T3-1 server is the platform of choice for Web infrastructure, Middleware workloads, and Application development. Delivering the world's first 16-core processor with unsurpassed throughput, the SPARC T3-1 server boasts speed, security, and unmatched availability to data in a sleek, compact design. Oracle's SPARC T3-1 server is a fully integrated system capable of running many virtual servers, helping drive up utilization, lower IT costs and keep server sprawl to a minimum.



Figure 1: The SPARC T3-1 server offers maximum security, speed, and scale for your Web infrastructure.

Product Overview

The SPARC T3-1 server, powered by the industry's first 16-core SPARC T3 processor and running the industry leading Oracle Solaris operating system, is the first 128-thread, general-purpose server offered in a 2 RU enclosure. It packs up to 16 cores and up to 128 simultaneous threads onto a single piece of silicon, together with the key functions of an entire system on a single chip—computing, networking, security, and I/O.

Moreover, SPARC T3-1 delivers highly expandable internal storage and network connectivity: the server can be configured with up to 16 disk drives and six PCI Express cards including the optional Oracle Sun Flash Accelerator F20 PCIe card and many other I/O options.

The SPARC T3-1 server offers Oracle VM for SPARC 2.0 and Oracle Solaris Containers enabling ultimate server virtualization and consolidation at a fraction of the cost of other vendors.

Finally, with integrated on-chip 10 Gigabit Ethernet and cryptographic acceleration, as well as smart integrated design using fewer parts, the SPARC T3-1 server offers a very safe and reliable platform to help you deploy applications.



SPARC T3-1 Server Specifications

Key Applications

- Web Infrastructure
- Middleware
- · Application Development
- · Multithreaded Applications
- Java Applications
- Virtualization and consolidation

Architecture

Processor

- One 16-core 1.65 GHz SPARC T3 processor, SPARC V9 architecture, ECC protected
- 6 MB integrated Level 2 (L2) cache
- Dual multithreaded 10 Gigabit Ethernet PCI integrated on the chip
- On-board cryptography supporting embedded security industry-standard cryptographic algorithms: AES, CRC32c, DES, 3DES, DH, DSA, ECC, Kasumi, MD5, RSA, SHA-1, SHA-256, SHA-384, SHA-512, plus random number generation (Note: CRC32c and Kasumi not currently supported by Solaris)

Main Memory

- 16 DIMM slots
- System maximum of 128 GB
- Support for 2 GB, 4 GB, and 8 GB DDR3 DIMMs

Interfaces

- Four 10/100/1000 Mb/sec Ethernet ports
- Up to 2x optional 10 GbE XAUI connections
- Six PCI Express 2.0 slots
- One RJ-45 serial management port and one RJ-45 network port for remote management
- Four USB 2.0 ports
- One HD15 VGA port
- One optional front accessible slim line SATA DVD+/-RW drive

Mass Storage	
Internal disk:	Up to eight or sixteen 2.5" SAS-2/SATA-2 front accessible hot pluggable disk drive bays, depending on selected backplane
	All bays can be populated with 300 GB or 600 GB SAS-2 hard disk drives. 32 GB SATA-2 Solid state drives are supported in the 8 disk backplane only.
	Optional Sun Flash Accelerator F20 PCle adapter card
External storage	Oracle offers a complete line of best-in-class, innovative storage hardware, software, and solutions— including tape drives, tape libraries, disk storage systems, data management software, and more—along with renowned world-class service and support.



Power

- Two hot-swappable AC 1200W redundant (N+1) power supplies
- Maximum operating input current at 100 VAC: 9.4 A
- Maximum operating input current at 200 VAC: 4.7 A
- Maximum operating input power at 100 VAC: 896W
- Maximum operating input power at 200 V AC: 888W

Key RAS Features

Hot pluggable disk drives

- Redundant, hot swappable power supplies and fans
- · Environmental monitoring
- · Error correction and parity checking
- · Easy component replacement
- · Electronic Prognostics
- Internal hardware drive mirroring (RAID 1)
- . RAID 0 and RAID 1 support

Software

Operating System

- Oracle Solaris 10 9/10
- Support for Solaris 10 10/09 + Oracle Solaris 10 9/10 Patch Bundle

Virtualization

Oracle VM Server for SPARC 2.0

Environment

Temperature

- Operating temperature: Sea level to 900 m (3,000 ft.): 5°C to 35°C (41°F to 95°F); above 900 m (2,953 ft.): decrease the maximum allowable temperature by 1°C/300 m (1.6°F/1,000 ft.); IEC 60068-2-1 Test Ad and 60068-2-2 Test Bd
- Nonoperating temperature: -40°C to 65°C (-40°F to 149°F); IEC 60068-2-1 Test Ab and 60068-2-2 Test Bb

Relative Humidity

- Operating relative humidity: 10% to 90% RH, 27°C maximum wet bulb (noncondensing); IEC 60068-2-56 Test Cb
- Nonoperating relative humidity: 93% RH, 35°C maximum wet bulb (noncondensing); IEC 60068-2-56 Test Cb

Altitude

- Operating altitude: 3,000 m (10,000 ft.); IEC 60068-2-13 Test M, and 60068-2-41 Test Z/BM
- Nonoperating altitude: 12,000 m (40,000 ft.); IEC 60068-2-13 Test M

Acoustic Noise

 Operating/idling acoustic noise 7.1 B (LwAd, 1 B = 10 dB), operating/idling acoustic noise 63 dB (LpAm, bystander positions)

Cooling

- Maximum heat dissipation at 100 VAC: 3057 BTU/hr
- Maximum heat dissipation at 200 VAC: 3030 BTU/hr
- 140 cfm maximum

Regulations



Safety: UL/CSA-60950-1, EN60950-1, IEC60950-1 CB Scheme with all country deviations, IEC825-1, 2, CFR21 part 1040, CNS14336, GB4943

RFI/EMC: EN55022 Class A, 47 CFR 15B Class A, ICES-003 Class A, VCCI Class A, AS/NZ3548 Class A, CNS 13438 Class A, KSC 5858 Class A, GB9254 Class A, EN61000-3-2, GB17625.1, EN61000-3-3

Immunity: EN55024, IEC 61000-4-2, IEC 61000-4-3, IEC 61000-4-4, IEC 61000-4-5, IEC 61000-4-6, IEC 61000-4-8, IEC 61000-4-11

Regulatory: CE, FCC, ICES-003, C-tick, VCCI, GOST-R, BSMI, MIC, UL/cUL, UL/DEMKOLVD, UL/S-mark, CCC

European Union Directives: 2006/95/EC (73/23/EEC) Low Voltage Directive, 2004/108/EC (89/336/EEC) EMC Directive, 2002/96/EC Waste Electrical and Electronic Equipment (WEEE) Directive, 2002/95/EC Restriction of Hazardous Substances (RoHS) Directive

Dimensions and Weight

Height: 88.65 mm (3.49 in.); 2 RU

Width: 447 mm (17.6 in.) Depth: 673.1 mm (26.5 in.)

Weight: Approximately 27.2 kg (60 lb.)

Warranty

Visit http://www.oracle.com/us/support/policies/index.html for Oracle's global warranty support information for the SPARC T3-2 server.

Services

Visit http://www.oracle.com/us/support/index.html for Oracle's service program offerings for the SPARC T3-2 server.

Contact Us

For more information about the Oracle SPARC T3-2 server, visit oracle.com or call +1.800.ORACLE1 to speak to an Oracle representative.



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Hardware and Software, Engineered to Work Together

